November 1998

FDS6875 Dual P-Channel 2.5V Specified PowerTrench[™] MOSFET

General Description

FAIRCHILD

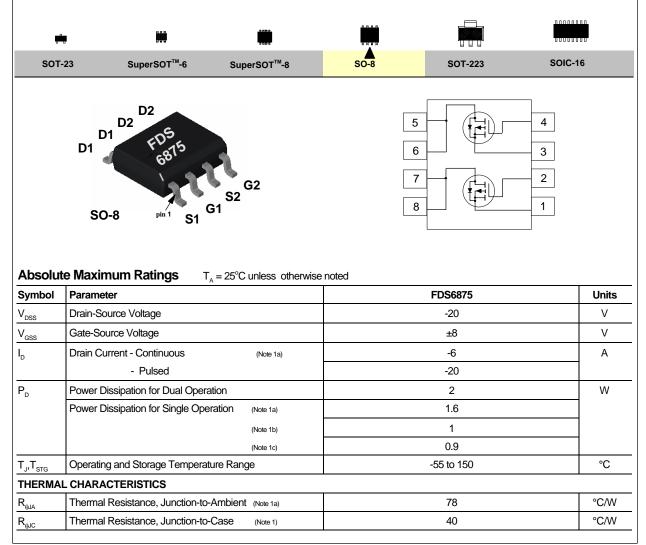
SEMICONDUCTOR IM

These P-Channel 2.5V specified MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

These devices are well suited for portable electronics applications: load switching and power management, battery charging and protection circuits.

Features

- $\begin{array}{c|c} \bullet & -6 \text{ A, -20 V. } \mathsf{R}_{\mathsf{DS(ON)}} = 0.030 \ \Omega & @ \ \mathsf{V}_\mathsf{GS} = -4.5 \ \mathsf{V}, \\ \mathsf{R}_{\mathsf{DS(ON)}} = 0.040 \ \Omega & @ \ \mathsf{V}_\mathsf{GS} = -2.5 \ \mathsf{V}. \end{array}$
- Low gate charge (23nC typical).
- High performance trench technology for extremely low R_{DS(ON)}.
- High power and current handling capability.

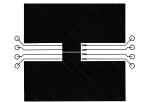


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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAF	ACTERISTICS					•	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-20			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = -250 µA, Referenced to	o 25 ℃		-21		mV/ºC
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$				-1	μA
			T _J = 55°C			-10	μA
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$				-100	nA
	CTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$		-0.4	-0.8	-1.5	V
$\Delta V_{GS(th)} / \Delta T_{J}$	Gate Threshold Voltage Temp. Coefficient	$I_D = 250 \mu\text{A}$, Referenced to $25 ^{\circ}\text{C}$			2.8		mV/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, I_{D} = -6 \text{ A}$			0.024	0.03	Ω
()			T_ =125°C		0.033	0.048	
		$V_{GS} = -2.5 \text{ V}, I_{D} = -5.3 \text{ A}$			0.032	0.04	
l _{D(ON)}	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-20			А
9 _{FS}	Forward Transconductance	$V_{DS} = -4.5 \text{ V}, I_{D} = -6 \text{ A}$			22		S
DYNAMIC	CHARACTERISTICS	•					
C _{iss}	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			2250		pF
C _{oss}	Output Capacitance				500		pF
C _{rss}	Reverse Transfer Capacitance				200		pF
SWITCHING	G CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	V_{DS} = -10 V, I_{D} = -1 A			8	16	ns
t,	Turn - On Rise Time	V_{gen} = -4.5 V, R_{gen} = 6 Ω			15	27	ns
t _{D(off)}	Turn - Off Delay Time				98	135	ns
t _r	Turn - Off Fall Time				35	55	ns
Q	Total Gate Charge	$V_{DS} = -10 \text{ V}, I_{D} = -6 \text{ A},$			23	31	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -5 V			3.9		nC
Q _{gd}	Gate-Drain Charge				5.5		nC
DRAIN-SO	JRCE DIODE CHARACTERISTICS AND MAX	IMUM RATINGS					
l _s	Maximum Continuous Drain-Source Diode Forward Current					-1.3	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -1.3 A$ (Note 2)			-0.7	-1.2	V

Notes:

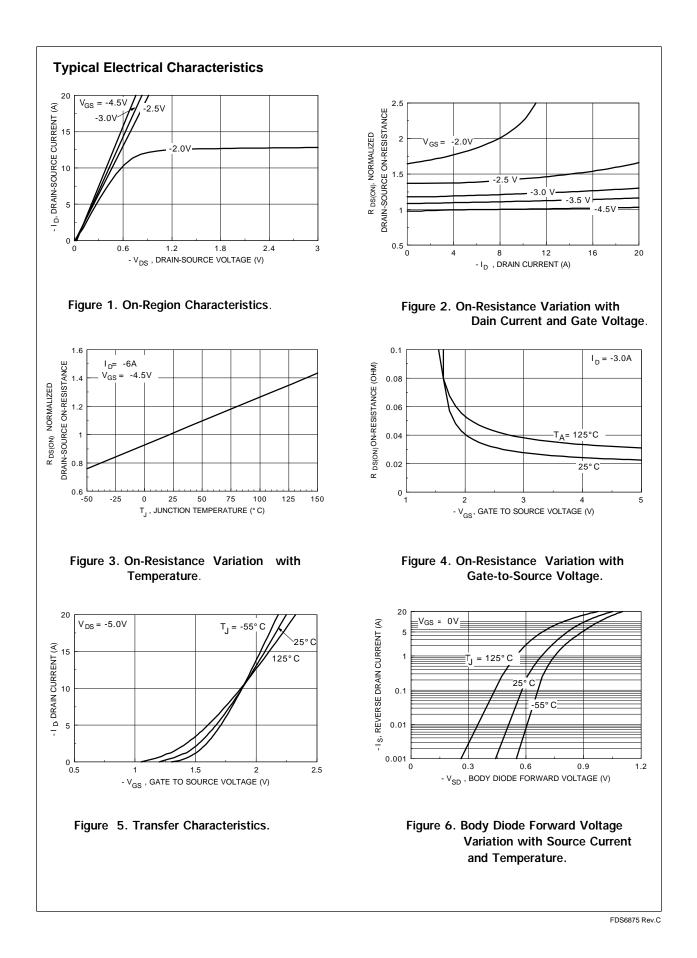
1. R_{BW} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BW} is guaranteed by design while R_{BW} is determined by the user's board design.

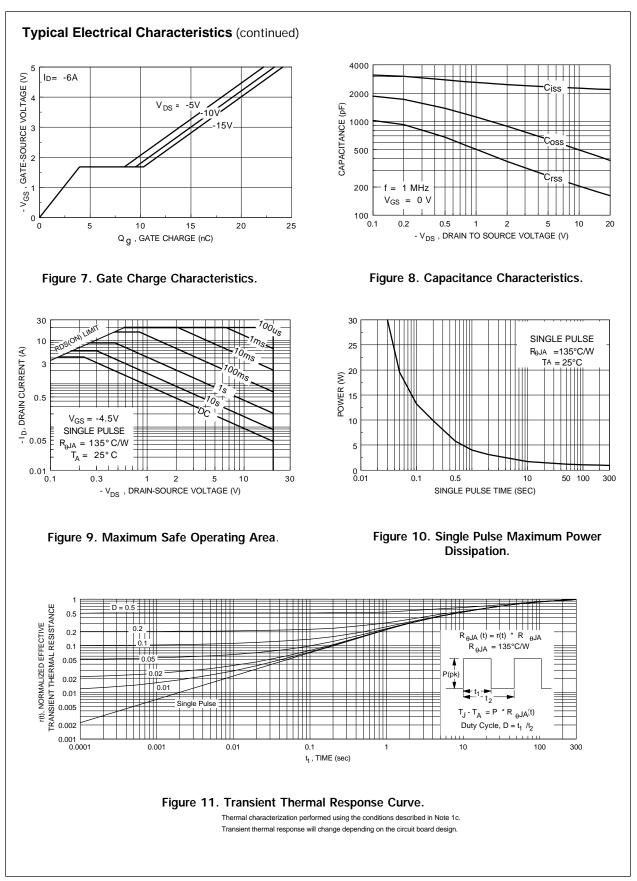


a. 78°C/W on a 0.5 in² pad of 2oz copper. b. 125°C/W on a 0.02 in² pad of 2oz copper. c. 135°C/W on a 0.003 in² pad of 2oz copper.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.





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